# 2SK3192

# Silicon N-channel power F-MOSFET

#### ■ Features

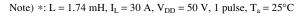
- Avalanche energy capacity guaranteed
- High-speed switching
- Low on-resistance
- No secondary breakdown

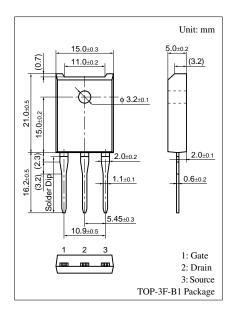
#### ■ Applications

- PDP
- Switching power supply

### ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter		Symbol	Rating	Unit
Drain-source breakdown voltage		$V_{\rm DSS}$	250	V
Gate to source voltage		V <sub>GSS</sub>	±30	V
Drain current	DC	$I_{\mathrm{D}}$	±30	A
	Pulse	$I_{DP}$	±120	A
Avalanche energy capacity *		EAS	925	mJ
Allowable power	$T_C = 25^{\circ}C$	$P_{\mathrm{D}}$	100	W
dissipation	$T_a = 25^{\circ}C$		3	
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature		$T_{stg}$	-55 to +150	°C



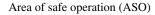


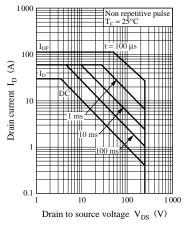
### ■ Electrical Characteristics $T_C = 25$ ° $C \pm 3$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain cutoff current	I <sub>DSS</sub>	$V_{DS} = 200 \text{ V}, V_{GS} = 0$			10	μΑ
Gate-source leakage current	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$			±1	μА
Drain-source breakdown voltage	V <sub>DSS</sub>	$I_D = 1 \text{ mA}, V_{GS} = 0$	250			V
Gate threshold voltage	V <sub>th</sub>	$V_{DS} = 10 \text{ V}, \ I_D = 1 \text{ mA}$	2		4	V
Drain-source on resistance	R <sub>DS(ON)</sub>	$V_{GS} = 10 \text{ V}, \ I_D = 15 \text{ A}$		50	68	mΩ
Forward transfer admittance	Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}, \ I_D = 15 \text{ A}$	8	15		S
Input capacitance	C <sub>iss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		4200		pF
Output capacitance	C <sub>oss</sub>			1600		pF
Reverse transfer capacitance	C <sub>rss</sub>			650		pF
Turn-on delay time	t <sub>d(ON)</sub>	$V_{DD} = 100 \text{ V}, \ I_D = 15 \text{ A}$		45		ns
Rise time	t <sub>r</sub>	$R_L = 6.7 \Omega, V_{GS} = 10 V$		115		ns
Turn-off deray time	t <sub>d(OFF)</sub>			330		ns
Fall time	t <sub>f</sub>			130		ns

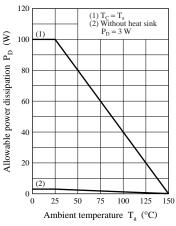
## ■ Electrical Characteristics (continued) $T_C = 25$ °C $\pm 3$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Diode forward voltage	V <sub>DSF</sub>	$I_{DR} = 30 \text{ A}, V_{GS} = 0$			-1.5	V
Reverse recovery time	t <sub>rr</sub>	$L = 230 \mu H, V_{DD} = 100 V$		260		ns
Reverse recovery charge	Q <sub>rr</sub>	$I_{DR} = 15 \text{ A}, \text{ di / dt} = 100 \text{ A / } \mu\text{s}$		1.6		μC
Total gate charge	Qg	$V_{DD} = 100 \text{ V}, I_D = 15 \text{ A}$		95		nC
Gate-source charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$		34		nC
Gate-drain charge	$Q_{gd}$			12		nC
Thermal resistance	R <sub>th(ch-c)</sub>				1.25	°C/W
(channel to case)						
Thermal resistance	R <sub>th(ch-a)</sub>				41.7	°C/W
(channel to ambient)						

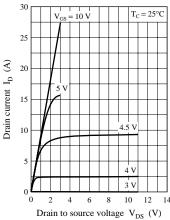


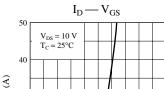


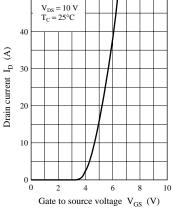
 $P_D - T_a$ 



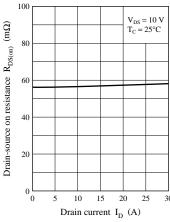
 $I_D - V_{DS}$ 







 $R_{DS(on)}$  —  $I_D$ 100

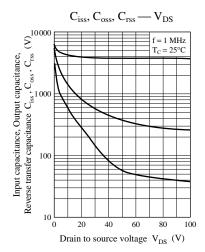


 $V_{DS} = 10 \text{ V}$  $T_C = 25^{\circ}\text{C}$ Forward transfer admittance  $|Y_{f_s}|$  (S) 20 10

10 15 20 25 30

Drain current  $I_D$  (A)

 $|\,Y_{fs}|\, {-\!\!\!\!\!-} \,I_D$ 



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